Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email & Skype: info@chipsmall.com Web: www.chipsmall.com
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

EVALUATION KIT AVAILABLE

MAX1908/MAX8724/ MAX8765/MAX8765A

Low-Cost Multichemistry Battery Chargers

General Description

The MAX1908/MAX8724/MAX8765/MAX8765A highly integrated, multichemistry battery-charger control ICs simplify the construction of accurate and efficient chargers. These devices use analog inputs to control charge current and voltage, and can be programmed by the host or hardwired. The MAX1908/MAX8724/MAX8765/MAX8765A achieve high efficiency using a buck topology with synchronous rectification.

The MAX1908/MAX8724/MAX8765/MAX8765A feature input current limiting. This feature reduces battery charge current when the input current limit is reached to avoid overloading the AC adapter when supplying the load and the battery charger simultaneously. The MAX1908/MAX8724/MAX8765/MAX8765A provide outputs to monitor current drawn from the AC adapter (DC input source), battery-charging current, and the presence of an AC adapter. The MAX1908's conditioning charge feature provides 300mA to safely charge deeply discharged lithium-ion (Li+) battery packs.

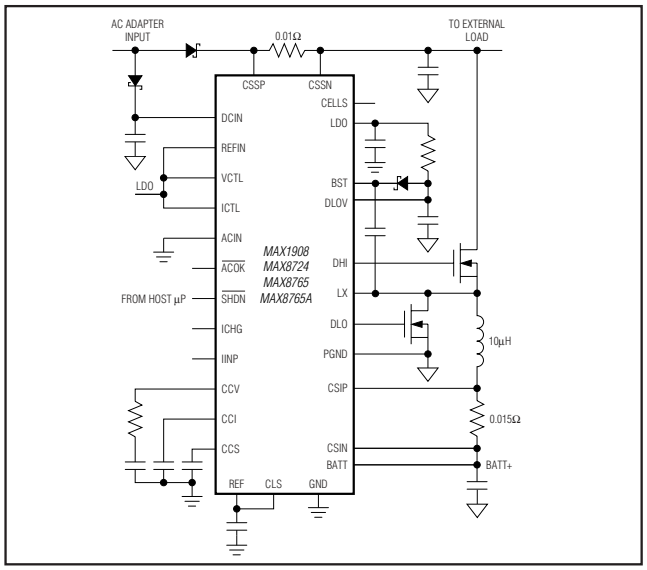
The MAX1908 includes a conditioning charge feature while the MAX8724/MAX8765/MAX8765A do not.

The MAX1908/MAX8724/MAX8765/MAX8765A charge two to four series Li+ cells, providing more than 5A, and are available in a space-saving, 28-pin, thin QFN package (5mm × 5mm). An evaluation kit is available to speed designs.

Applications

Notebook and Subnotebook Computers
Personal Digital Assistants
Handheld Terminals

Minimum Operating Circuit



Features

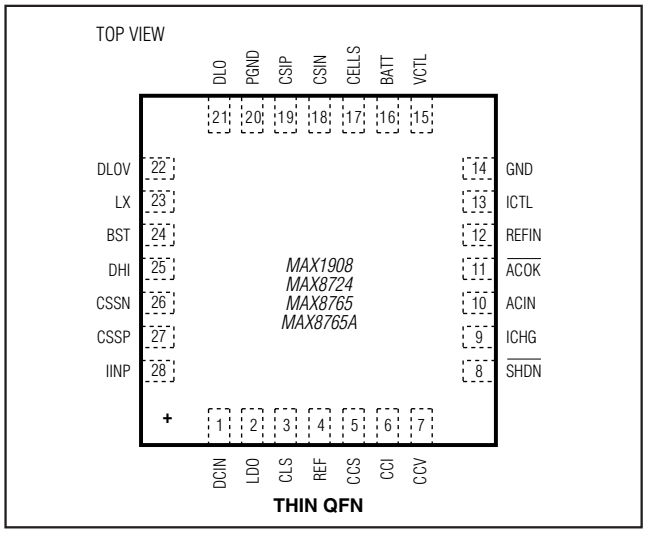
- ±0.5% Output Voltage Accuracy Using Internal Reference (±0.4% for MAX8765A, 2-/3-Cell Only)
- ±4% Accurate Input Current Limiting
- ±5% Accurate Charge Current
- Analog Inputs Control Charge Current and Charge Voltage
- Outputs for Monitoring
  - Current Drawn from AC Adapter
  - Charging Current
  - AC Adapter Presence
- Up to 17.6V Battery-Voltage Set Point
- Maximum 28V Input Voltage
- > 95% Efficiency
- Shutdown Control Input
- Charge Any Battery Chemistry
  - Li+, NiCd, NiMH, Lead Acid, etc.

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX1908ETI+	-40°C to +85°C	28 Thin QFN-EP*
MAX8724ETI+	-40°C to +85°C	28 Thin QFN-EP*
MAX8765ETI+	-40°C to +85°C	28 Thin QFN-EP*
MAX8765AETI+	-40°C to +85°C	28 Thin QFN-EP*

+Denotes a lead(Pb)-free/RoHS-compliant package.
**EP = Exposed pad.*

Pin Configuration



For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maximintegrated.com.

19-2764; Rev 5; 11/09

ABSOLUTE MAXIMUM RATINGS

DCIN, CSSP, CSSN, $\overline{ACOK}$ to GND .....-0.3V to +30V
BST to GND .....-0.3V to +36V
BST to LX .....-0.3V to +6V
DHI to LX .....-0.3V to (V_{BST} + 0.3V)
LX to GND .....-6V to +30V
BATT, CSIP, CSIN to GND .....-0.3V to +20V
CSIP to CSIN or CSSP to CSSN or PGND to GND .....-0.3V to +0.3V
CCI, CCS, CCV, DLO, ICHG, IINP, ACIN, REF to GND .....-0.3V to (V_{LDO} + 0.3V)
DLOV, VCTL, ICTL, REFIN, CELLS, CLS, LDO, $\overline{SHDN}$ to GND .....-0.3V to +6V
DLOV to LDO .....-0.3V to +0.3V
DLO to PGND .....-0.3V to (V_{DLOV} + 0.3V)
LDO Short-Circuit Current 50mA
Continuous Power Dissipation (T_A = +70°C)
28-Pin Thin QFN (5mm × 5mm)
(derate 20.8mW/°C above +70°C) 1666.7mW
Operating Temperature Range .....-40°C to +85°C
Junction Temperature .....+150°C
Storage Temperature Range .....-60°C to +150°C
Lead Temperature (soldering, 10s) .....+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{DCIN} = V_{CSSP} = V_{CSSN} = 18V, V_{BATT} = V_{CSIP} = V_{CSIN} = 12V, V_{REFIN} = 3V, V_{VCTL} = V_{ICTL} = 0.75 x V_{REFIN}, CELLS = open, CLS = REF, V_{BST} - V_{LX} = 4.5V, ACIN = GND = PGND = 0, C_{LDO} = 1µF, LDO = DLOV, C_{REF} = 1µF; CCI, CCS, and CCV are compensated per Figure 1a; **T_A = 0°C to +85°C**, unless otherwise noted. Typical values are at T_A = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
CHARGE-VOLTAGE REGULATION						
Battery-Regulation Voltage Accuracy (MAX1908/MAX8724/MAX8765 (2, 3, or 4 Cells) and MAX8765A (4 Cells Only))		V_{VCTL} = V_{REFIN}	-0.5		+0.5	%
		V_{VCTL} = V_{REFIN}/20	-0.5		+0.5	
		V_{VCTL} = V_{LDO}	-0.5		+0.5	
Battery-Regulation Voltage Accuracy (MAX8765A, 2 or 3 Cells Only)		V_{VCTL} = V_{REFIN}	-0.4		+0.4	%
		V_{VCTL} = V_{REFIN}/20	-0.4		+0.4	
		V_{VCTL} = V_{LDO}	-0.4		+0.4	
VCTL Default Threshold		V_{VCTL} rising	4.0	4.1	4.2	V
REFIN Range		(Note 1)	2.5		3.6	V
REFIN Undervoltage Lockout		V_{REFIN} falling		1.20	1.92	V
CHARGE-CURRENT REGULATION						
CSIP-to-CSIN Full-Scale Current-Sense Voltage		V_{ICTL} = V_{REFIN}	71.25	75	78.75	mV
Charging-Current Accuracy		V_{ICTL} = V_{REFIN}	-5		+5	%
		V_{ICTL} = V_{REFIN} x 0.6	-5		+5	
		V_{ICTL} = V_{LDO}	-6		+6	
		MAX8765/MAX8765A only; V_{ICTL} = V_{REFIN} x 0.036	-45		+45	
		MAX8724 only; V_{ICTL} = V_{REFIN} x 0.058	-33		+33	
Charge-Current Gain Error (MAX8765/MAX8765A Only)			-2		+2	%
Charge-Current Offset (MAX8765/MAX8765A Only)			-2		+2	mV
ICTL Default Threshold		V_{ICTL} rising	4.0	4.1	4.2	V
BATT/CSIP/CSIN Input Voltage Range			0		19	V

ELECTRICAL CHARACTERISTICS (continued)

(V_{DCIN} = V_{CSSP} = V_{CSSN} = 18V, V_{BATT} = V_{CSIP} = V_{CSIN} = 12V, V_{REFIN} = 3V, V_{VCTL} = V_{ICTL} = 0.75 x V_{REFIN}, CELLS = open, CLS = REF, V_{BST} - V_{LX} = 4.5V, ACIN = GND = PGND = 0, C_{LDO} = 1µF, LDO = DLOV, C_{REF} = 1µF; CCI, CCS, and CCV are compensated per Figure 1a; **T_A = 0°C to +85°C**, unless otherwise noted. Typical values are at T_A = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
CSIP/CSIN Input Current		V_{DCIN} = 0V or V_{ICTL} = 0V or $V_{\overline{SHDN}}$ = 0V			1	µA
		Charging		400	650	
Cycle-by-Cycle Maximum Current Limit		RS2 = 0.015mΩ	6.0	6.8	7.5	A
ICTL Power-Down Mode Threshold Voltage (MAX1908/MAX8724 Only)		V_{VCTL} rising	REFIN/100	REFIN/55	REFIN/33	V
ICTL, VCTL Input Bias Current		V_{VCTL} = V_{ICTL} = 0 or 3V	-1		+1	µA
		V_{DCIN} = 0V, V_{VCTL} = V_{ICTL} = V_{REFIN} = 5V	-1		+1	
REFIN Input Bias Current		V_{DCIN} = 5V, V_{REFIN} = 3V	-1		+1	µA
		V_{REFIN} = 5V	-1		+1	
ICHG Transconductance (MAX1908/MAX8724 Only)	G_{ICHG}	V_{CSIP} - V_{CSIN} = 45mV	2.7	3	3.3	µA/mV
ICHG Transconductance (MAX8765/MAX8765A Only)	G_{ICHG}	V_{CSIP} - V_{CSIN} = 45mV	2.85	3	3.15	µA/mV
ICHG Transconductance Error (MAX8765/MAX8765A Only)			-5		+5	%
ICHG Transconductance Offset (MAX8765/MAX8765A Only)			-5		+5	µA
ICHG Accuracy		V_{CSIP} - V_{CSIN} = 75mV	-6		+6	%
		V_{CSIP} - V_{CSIN} = 45mV	-5		+5	
		V_{CSIP} - V_{CSIN} = 5mV	-40		+40	
ICHG Output Current		V_{CSIP} - V_{CSIN} = 150mV, V_{ICHG} = 0V	350			µA
ICHG Output Voltage		V_{CSIP} - V_{CSIN} = 150mV, ICHG = open	3.5			V
INPUT-CURRENT REGULATION						
CSSP-to-CSSN Full-Scale Current-Sense Voltage			72	75	78	mV
Input Current-Limit Accuracy		V_{CLS} = V_{REF}	-4		+4	%
		V_{CLS} = V_{REF}/2	-7.5		+7.5	
		V_{CLS} = 1.1V (MAX8765/MAX8765A only)	-10		+10	
Input Current-Limit Gain Error (MAX8765/MAX8765A Only)			-2		+2	%
Input Current-Limit Offset (MAX8765/MAX8765A Only)			-2		+2	mV
CSSP, CSSN Input Voltage Range			8		28	V
CSSP, CSSN Input Current (MAX1908/MAX8724 Only)		V_{DCIN} = 0V		0.1	1	µA
		V_{CSSP} = V_{CSSN} = V_{DCIN} > 8V		350	600	
CSSP Input Current (MAX8765/MAX8765A Only)		V_{CSSP} = V_{CSSN} = 28V, V_{DCIN} = 0V		0.1	1	µA
		V_{CSSP} = V_{CSSN} = 28V, V_{DCIN} = 28V		400	650	

ELECTRICAL CHARACTERISTICS (continued)

(V_{DCIN} = V_{CSSP} = V_{CSSN} = 18V, V_{BATT} = V_{CSIP} = V_{CSIN} = 12V, V_{REFIN} = 3V, V_{VCTL} = V_{ICTL} = 0.75 x V_{REFIN}, CELLS = open, CLS = REF, V_{BST} - V_{LX} = 4.5V, ACIN = GND = PGND = 0, C_{LDO} = 1µF, LDO = DLOV, C_{REF} = 1µF; CCI, CCS, and CCV are compensated per Figure 1a; **T_A = 0°C to +85°C**, unless otherwise noted. Typical values are at T_A = +25°C.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
CSSN Input Current (MAX8765/MAX8765A Only)		V_{CSSP} = V_{CSSN} = 28V	V_{DCIN} = 0V		0.1	1	µA
			V_{DCIN} = 28V		0.1	1	
CLS Input Range (MAX1908/MAX8724 Only)				1.6		REF	V
CLS Input Range (MAX8765/MAX8765A Only)				1.1		REF	V
CLS Input Bias Current		V_{CLS} = 2V		-1		+1	µA
IINP Transconductance (MAX1908/MAX8724 Only)	G_{IINP}	V_{CSSP} - V_{CSSN} = 75mV		2.7	3	3.3	µA/mV
IINP Accuracy		V_{CSSP} - V_{CSSN} = 75mV		-5		+5	%
		V_{CSSP} - V_{CSSN} = 37.5mV		-7.5		+7.5	
IINP Transconductance (MAX8765/MAX8765A Only)	G_{IINP}	V_{CSSP} - V_{CCSN} = 75mV		2.82	3	3.18	µA/mV
IINP Transconductance Error (MAX8765/MAX8765A Only)				-6		+6	%
IINP Transconductance Offset (MAX8765/MAX8765A Only)				-10		+10	µA
IINP Output Current		V_{CSSP} - V_{CSSN} = 150mV, V_{IINP} = 0V		350			µA
IINP Output Voltage		V_{CSSP} - V_{CSSN} = 150mV, V_{IINP} = open		3.5			V
SUPPLY AND LDO REGULATOR							
DCIN Input Voltage Range	V_{DCIN}			8		28	V
DCIN Undervoltage-Lockout Trip Point		V_{DCIN} falling		7	7.4		V
		V_{DCIN} rising			7.5	7.85	
DCIN Quiescent Current	I_{DCIN}	8.0V < V_{DCIN} < 28V			3.2	6	mA
BATT Input Current	I_{BATT}	V_{BATT} = 19V, V_{DCIN} = 0V				1	µA
		V_{BATT} = 2V to 19V, V_{DCIN} = 19.3V			200	500	
LDO Output Voltage		8V < V_{DCIN} < 28V, no load		5.25	5.4	5.55	V
LDO Load Regulation		0 < I_{LDO} < 10mA			34	100	mV
LDO Undervoltage-Lockout Trip Point		V_{DCIN} = 8V		3.20	4	5.15	V
REFERENCE							
REF Output Voltage		0 < I_{REF} < 500µA		4.072	4.096	4.120	V
REF Undervoltage-Lockout Trip Point		V_{REF} falling			3.1	3.9	V

ELECTRICAL CHARACTERISTICS (continued)

(V_{DCIN} = V_{CSSP} = V_{CSSN} = 18V, V_{BATT} = V_{CSIP} = V_{CSIN} = 12V, V_{REFIN} = 3V, V_{VCTL} = V_{ICTL} = 0.75 x V_{REFIN}, CELLS = open, CLS = REF, V_{BST} - V_{LX} = 4.5V, ACIN = GND = PGND = 0, C_{LDO} = 1µF, LDO = DLOV, C_{REF} = 1µF; CCI, CCS, and CCV are compensated per Figure 1a; **T_A = 0°C to +85°C**, unless otherwise noted. Typical values are at T_A = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
TRIP POINTS						
BATT Power-Fail Threshold		V_{DCIN} falling, referred to V_{CSIN} (MAX1908/MAX8724 only)	50	100	150	mV
		V_{CSSP} falling, referred to V_{CSIN} (MAX8765/MAX8765A only)	50	100	150	
BATT Power-Fail Threshold Hysteresis				200		mV
ACIN Threshold		ACIN rising (MAX8765/MAX8765A only)	2.028	2.048	2.068	V
		ACIN rising (MAX1908/MAX8724 only)	2.007	2.048	2.089	
ACIN Threshold Hysteresis		0.5% of REF		20		mV
ACIN Input Bias Current		V_{ACIN} = 2.048V	-1		+1	µA
SWITCHING REGULATOR						
DHI Off-Time		V_{BATT} = 16V, V_{DCIN} = 19V, V_{CELLS} = V_{REFIN}	0.36	0.4	0.44	µs
DHI Minimum Off-Time		V_{BATT} = 16V, V_{DCIN} = 17V, V_{CELLS} = V_{REFIN}	0.24	0.28	0.33	µs
DHI Maximum On-Time			2.5	5	7.5	ms
DLOV Supply Current		DLO low		5	10	µA
BST Supply Current		DHI high		6	15	µA
BST Input Quiescent Current		V_{DCIN} = 0V, V_{BST} = 24.5V, V_{BATT} = V_{LX} = 20V		0.3	1	µA
LX Input Bias Current		V_{DCIN} = 28V, V_{BATT} = V_{LX} = 20V		150	500	µA
LX Input Quiescent Current		V_{DCIN} = 0V, V_{BATT} = V_{LX} = 20V		0.3	1	µA
DHI Maximum Duty Cycle			99	99.9		%
Minimum Discontinuous-Mode Ripple Current				0.5		A
Battery Undervoltage Charge Current		V_{BATT} = 3V per cell (RS2 = 15mΩ), MAX1908 only, V_{BATT} rising	150	300	450	mA
Battery Undervoltage Current Threshold		CELLS = GND, MAX1908 only, V_{BATT} rising	6.1	6.2	6.3	V
		CELLS = open, MAX1908 only, V_{BATT} rising	9.15	9.3	9.45	
		CELLS = V_{REFIN}, MAX1908 only, V_{BATT} rising	12.2	12.4	12.6	
DHI On-Resistance High		V_{BST} - V_{LX} = 4.5V, I_{DHI} = +100mA		4	7	Ω
DHI On-Resistance Low		V_{BST} - V_{LX} = 4.5V, I_{DHI} = -100mA		1	3.5	Ω
DLO On-Resistance High		V_{DLOV} = 4.5V, I_{DLO} = +100mA		4	7	Ω
DLO On-Resistance Low		V_{DLOV} = 4.5V, I_{DLO} = -100mA		1	3.5	Ω

ELECTRICAL CHARACTERISTICS (continued)

(V_{DCIN} = V_{CSSP} = V_{CSSN} = 18V, V_{BATT} = V_{CSIP} = V_{CSIN} = 12V, V_{REFIN} = 3V, V_{VCTL} = V_{ICTL} = 0.75 x V_{REFIN}, CELLS = open, CLS = REF, V_{BST} - V_{LX} = 4.5V, ACIN = GND = PGND = 0, C_{LDO} = 1µF, LDO = DLOV, C_{REF} = 1µF; CCI, CCS, and CCV are compensated per Figure 1a; **T_A = 0°C to +85°C**, unless otherwise noted. Typical values are at T_A = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
ERROR AMPLIFIERS						
GMV Amplifier Transconductance	GMV	V_{VCTL} = V_{LDO}, V_{BATT} = 16.8V, CELLS = V_{REFIN}	0.0625	0.125	0.2500	µA/mV
GMI Amplifier Transconductance	GMI	V_{ICTL} = V_{REFIN}, V_{CSIP} - V_{CSIN} = 75mV	0.5	1	2.0	µA/mV
GMS Amplifier Transconductance	GMS	V_{CLS} = V_{REF}, V_{CSSP} - V_{CSSN} = 75mV	0.5	1	2.0	µA/mV
CCI, CCS, CCV Clamp Voltage		0.25V < $V_{CCV,CCS,CCI}$ < 2V	150	300	600	mV
LOGIC LEVELS						
CELLS Input Low Voltage					0.4	V
CELLS Input Open Voltage		CELLS = open	(V_{REFIN} /2) - 0.2V	V_{REFIN}/ 2	(V_{REFIN} /2) + 0.2V	V
CELLS Input High Voltage			V_{REFIN} - 0.4V			V
CELLS Input Bias Current		CELLS = 0V or V_{REFIN}	-2		+2	µA
$\overline{ACOK}$ AND $\overline{SHDN}$						
$\overline{ACOK}$ Input Voltage Range			0		28	V
$\overline{ACOK}$ Sink Current		$V_{\overline{ACOK}}$ = 0.4V, V_{ACIN} = 3V	1			mA
$\overline{ACOK}$ Leakage Current		$V_{\overline{ACOK}}$ = 28V, V_{ACIN} = 0V			1	µA
$\overline{SHDN}$ Input Voltage Range			0		LDO	V
$\overline{SHDN}$ Input Bias Current		$V_{\overline{SHDN}}$ = 0V OR V_{LDO}	-1		+1	µA
		$V_{\overline{SHDN}}$ = 0V OR $V_{\overline{SHDN}}$ = 5V	-1		+1	
$\overline{SHDN}$ Threshold		$V_{\overline{SHDN}}$ falling	22	23.5	25	% of V_{REFIN}
$\overline{SHDN}$ Threshold Hysteresis				1		% of V_{REFIN}

ELECTRICAL CHARACTERISTICS

(V_{DCIN} = V_{CSSP} = V_{CSSN} = 18V, V_{BATT} = V_{CSIP} = V_{CSIN} = 12V, V_{REFIN} = 3V, V_{VCTL} = V_{ICTL} = 0.75 x V_{REFIN}, CELLS = open, CLS = REF, V_{BST} - V_{LX} = 4.5V, ACIN = GND = PGND = 0, C_{LDO} = 1µF, LDO = DLOV, C_{REF} = 1µF; CCI, CCS, and CCV are compensated per Figure 1a; **T_A = -40°C to +85°C**, unless otherwise noted.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
CHARGE-VOLTAGE REGULATION						
Battery Regulation Voltage Accuracy (2, 3, or 4 Cells)		V_{VCTL} = V_{REFIN}	-0.6		+0.6	%
		V_{VCTL} = V_{REFIN}/20	-0.6		+0.6	
		V_{VCTL} = V_{LDO}	-0.6		+0.6	
REFIN Range		(Note 1)	2.5		3.6	V
REFIN Undervoltage Lockout		V_{REFIN} falling			1.92	V
CHARGE CURRENT REGULATION						
CSIP-to-CSIN Full-Scale Current-Sense Voltage		V_{ICTL} = V_{REFIN}	70.5		79.5	mV
Charging-Current Accuracy		V_{ICTL} = V_{REFIN}	-6		+6	%
		V_{ICTL} = V_{REFIN} x 0.6	-7.5		+7.5	
		V_{ICTL} = V_{LDO}	-7.5		+7.5	
		MAX8765/MAX8765A only; V_{ICTL} = V_{REFIN} x 0.036	-50		+50	
		MAX8724 only; V_{ICTL} = V_{REFIN} x 0.058	-33		+33	
Charge-Current Gain Error (MAX8765/MAX8765A Only)			-2		+2	%
Charge-Current Offset (MAX8765/MAX8765A Only)			-2		+2	mV
BATT/CSIP/CSIN Input Voltage Range			0		19	V
CSIP/CSIN Input Current		V_{DCIN} = 0V or V_{ICTL} = 0V or $V_{\overline{SHDN}}$ = 0V			1	µA
		Charging			650	
Cycle-by-Cycle Maximum Current Limit	I_{MAX}	RS2 = 0.015Ω	6.0		7.5	A
ICTL Power-Down Mode Threshold Voltage (MAX1908/MAX8724 Only)		V_{ICTL} rising	REFIN/100		REFIN/33	V
ICHG Transconductance (MAX1908/MAX8724 Only)	G_{ICHG}	V_{CSIP} - V_{CSIN} = 45mV	2.7		3.3	µA/mV
ICHG Transconductance (MAX8765/MAX8765A Only)	G_{ICHG}	V_{CSIP} - V_{CSIN} = 45mV	2.785		3.225	µA/mV
ICHG Transconductance Error (MAX8765/MAX8765A Only)			-7.5		+7.5	%
ICHG Transconductance Offset (MAX8765/MAX8765A Only)			-6.5		+6.5	µA

ELECTRICAL CHARACTERISTICS (continued)

(V_{DCIN} = V_{CSSP} = V_{CSSN} = 18V, V_{BATT} = V_{CSIP} = V_{CSIN} = 12V, V_{REFIN} = 3V, V_{VCTL} = V_{ICTL} = 0.75 x V_{REFIN}, CELLS = open, CLS = REF, V_{BST} - V_{LX} = 4.5V, ACIN = GND = PGND = 0, C_{LDO} = 1µF, LDO = DLOV, C_{REF} = 1µF; CCI, CCS, and CCV are compensated per Figure 1a; **T_A = -40°C to +85°C**, unless otherwise noted.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
ICHG Accuracy		V_{CSIP} - V_{CSIN} = 75mV		-7.5		+7.5	%
		V_{CSIP} - V_{CSIN} = 45mV		-7.5		+7.5	
		V_{CSIP} - V_{CSIN} = 5mV		-40		+40	
INPUT-CURRENT REGULATION							
CSSP-to-CSSN Full-Scale Current-Sense Voltage				71.25		78.75	mV
Input Current-Limit Accuracy		V_{CLS} = V_{REF}		-5		+5	%
		V_{CLS} = V_{REF}/2		-7.5		+7.5	
		V_{CLS} = 1.1V (MAX8765/MAX8765A only)		-10		+10	
Input Current-Limit Gain Error (MAX8765/MAX8765A Only)				-2		+2	%
Input Current-Limit Offset (MAX8765/MAX8765A Only)				-2		+2	mV
CSSP, CSSN Input Voltage Range				8		28	V
CSSP, CSSN Input Current (MAX1908/MAX8724 Only)		V_{DCIN} = 0V				1	µA
		V_{CSSP} = V_{CSSN} = V_{DCIN} > 8V				600	
CSSP Input Current (MAX8765/MAX8765A Only)		V_{CSSP} = V_{CSSN} = 28V	V_{DCIN} = 0V			1	µA
			V_{DCIN} = 28V			650	
CSSN Input Current (MAX8765/MAX8765A Only)		V_{CSSP} = V_{CSSN} = 28V	V_{DCIN} = 0V			1	µA
			V_{DCIN} = 28V			1	
CLS Input Range (MAX1908/MAX8724 Only)				1.6		REF	V
CLS Input Range (MAX8765/MAX8765A Only)				1.1		REF	V
IINP Transconductance (MAX1908/MAX8724 Only)	G_{IINP}	V_{CSSP} - V_{CSSN} = 75mV		2.7		3.3	µA/mV
IINP Transconductance (MAX8765/MAX8765A Only)	G_{IINP}	V_{CSSP} - V_{CCSN} = 75mV		2.785		3.225	µA/mV
IINP Transconductance Error (MAX8765/MAX8765A Only)				-7.5		+7.5	%
IINP Transconductance Offset (MAX8765/MAX8765A Only)				-12		+12	µA
IINP Accuracy		V_{CSSP} - V_{CSSN} = 75mV		-7.5		+7.5	%
		V_{CSSP} - V_{CSSN} = 37.5mV		-7.5		+7.5	

ELECTRICAL CHARACTERISTICS (continued)

(V_{DCIN} = V_{CSSP} = V_{CSSN} = 18V, V_{BATT} = V_{CSIP} = V_{CSIN} = 12V, V_{REFIN} = 3V, V_{VCTL} = V_{ICTL} = 0.75 x V_{REFIN}, CELLS = open, CLS = REF, V_{BST} - V_{LX} = 4.5V, ACIN = GND = PGND = 0, C_{LDO} = 1µF, LDO = DLOV, C_{REF} = 1µF; CCI, CCS, and CCV are compensated per Figure 1a; **T_A = -40°C to +85°C**, unless otherwise noted.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
SUPPLY AND LDO REGULATOR						
DCIN Input Voltage Range	V_{DCIN}		8		28	V
DCIN Quiescent Current	I_{DCIN}	8.0V < V_{DCIN} < 28V			6	mA
BATT Input Current	I_{BATT}	V_{BATT} = 19V, V_{DCIN} = 0V			1	µA
		V_{BATT} = 2V to 19V, V_{DCIN} = 19.3V			500	
LDO Output Voltage		8V < V_{DCIN} < 28V, no load	5.25		5.55	V
LDO Load Regulation		0 < I_{LDO} < 10mA			100	mV
REFERENCE						
REF Output Voltage		0 < I_{REF} < 500µA	4.065		4.120	V
TRIP POINTS						
BATT Power-Fail Threshold		V_{DCIN} falling, referred to V_{CSIN} (MAX1908/MAX8724 only)	50		150	mV
		V_{CSSP} falling, referred to V_{CSIN} (MAX8765/MAX8765A only)	50		150	
ACIN Threshold		ACIN rising (MAX8765/MAX8765A only)	2.028		2.068	V
		ACIN rising (MAX1908/MAX8724 only)	2.007		2.089	
SWITCHING REGULATOR						
DHI Off-Time		V_{BATT} = 16V, V_{DCIN} = 19V, V_{CELLS} = V_{REFIN}	0.35		0.45	µs
DHI Minimum Off-Time		V_{BATT} = 16V, V_{DCIN} = 17V, V_{CELLS} = V_{REFIN}	0.24		0.33	µs
DHI Maximum On-Time			2.5		7.5	ms
DHI Maximum Duty Cycle			99			%
Battery Undervoltage Charge Current		V_{BATT} = 3V per cell (RS2 = 15mΩ), MAX1908 only, V_{BATT} rising	150		450	mA
Battery Undervoltage Current Threshold		CELLS = GND, MAX1908 only, V_{BATT} rising	6.09		6.30	V
		CELLS = open, MAX1908 only, V_{BATT} rising	9.12		9.45	
		CELLS = V_{REFIN}, MAX1908 only, V_{BATT} rising	12.18		12.60	
DHI On-Resistance High		V_{BST} - V_{LX} = 4.5V, I_{DHI} = +100mA			7	Ω
DHI On-Resistance Low		V_{BST} - V_{LX} = 4.5V, I_{DHI} = -100mA			3.5	Ω
DLO On-Resistance High		V_{DLOV} = 4.5V, I_{DLO} = +100mA			7	Ω
DLO On-Resistance Low		V_{DLOV} = 4.5V, I_{DLO} = -100mA			3.5	Ω

ELECTRICAL CHARACTERISTICS (continued)

(V_{DCIN} = V_{CSSP} = V_{CSSN} = 18V, V_{BATT} = V_{CSIP} = V_{CSIN} = 12V, V_{REFIN} = 3V, V_{VCTL} = V_{ICTL} = 0.75 x V_{REFIN}, CELLS = open, CLS = REF, V_{BST} - V_{LX} = 4.5V, ACIN = GND = PGND = 0, C_{LDO} = 1µF, LDO = DLOV, C_{REF} = 1µF; CCI, CCS, and CCV are compensated per Figure 1a; **T_A = -40°C to +85°C**, unless otherwise noted.) (Note 2)

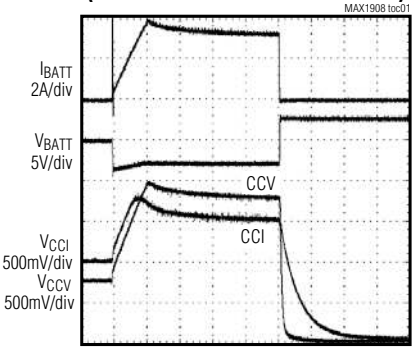
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
ERROR AMPLIFIERS						
GMV Amplifier Transconductance	GMV	V_{VCTL} = V_{LDO}, V_{BATT} = 16.8V, CELLS = V_{REFIN}	0.0625		0.250	µA/mV
GMI Amplifier Transconductance	GMI	V_{ICTL} = V_{REFIN}, V_{CSIP} - V_{CSIN} = 75mV	0.5		2.0	µA/mV
GMS Amplifier Transconductance	GMS	V_{CLS} = V_{REF}, V_{CSSP} - V_{CSSN} = 75mV	0.5		2.0	µA/mV
CCI, CCS, CCV Clamp Voltage		0.25V < $V_{CCV,CCS,CCI}$ < 2V	150		600	mV
LOGIC LEVELS						
CELLS Input Low Voltage					0.4	V
CELLS Input Open Voltage		CELLS = open	(V_{REFIN} /2) - 0.2V		(V_{REFIN} /2) + 0.2V	V
CELLS Input High Voltage			V_{REFIN} - 0.4V			V
$\overline{ACOK}$ AND $\overline{SHDN}$						
$\overline{ACOK}$ Input Voltage Range			0		28	V
$\overline{ACOK}$ Sink Current		$V_{\overline{ACOK}}$ = 0.4V, V_{ACIN} = 3V	1			mA
$\overline{SHDN}$ Input Voltage Range			0		LDO	V
$\overline{SHDN}$ Threshold		$V_{\overline{SHDN}}$ falling	22		25	% of V_{REFIN}

Note 1: If both ICTL and VCTL use default mode (connected to LDO), REFIN is not used and can be connected to LDO.
Note 2: Specifications to T_A = -40°C are guaranteed by design and not production tested.

Typical Operating Characteristics

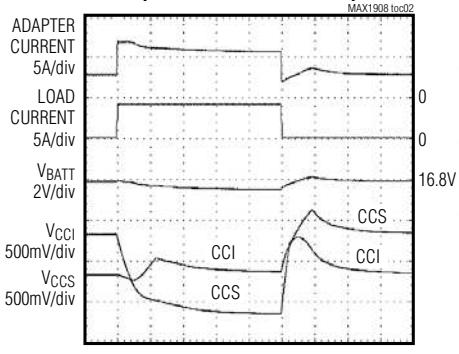
(Circuit of Figure 1, V_{DCIN} = 20V, T_A = +25°C, unless otherwise noted.)

LOAD-TRANSIENT RESPONSE (BATTERY INSERTION AND REMOVAL)



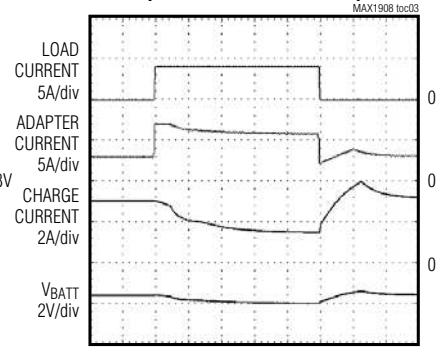
ICTL = LDO
VCTL = LDO

LOAD-TRANSIENT RESPONSE (STEP IN-LOAD CURRENT)



ICTL = LDO
CHARGING CURRENT = 3A
V_{BATT} = 16.8V
LOAD STEP = 0 TO 4A
I_{SOURCE} LIMIT = 5A

LOAD-TRANSIENT RESPONSE (STEP IN-LOAD CURRENT)

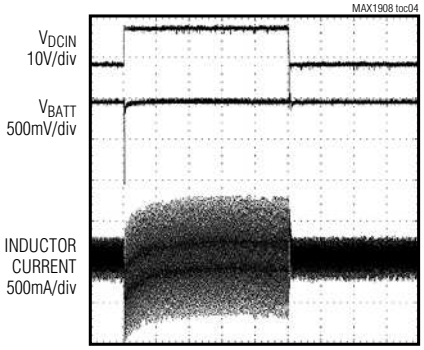


ICTL = LDO
CHARGING CURRENT = 3A
V_{BATT} = 16.8V
LOAD STEP = 0 TO 4A
I_{SOURCE} LIMIT = 5A

Typical Operating Characteristics (continued)

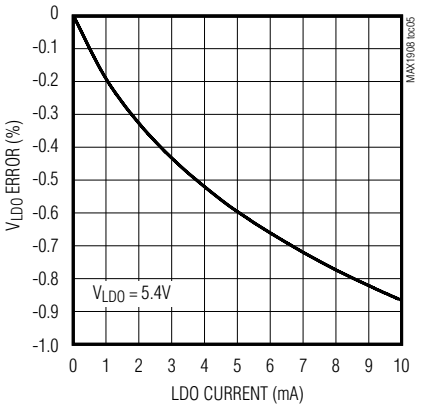
(Circuit of Figure 1, V_{DCIN} = 20V, T_A = +25°C, unless otherwise noted.)

LINE-TRANSIENT RESPONSE

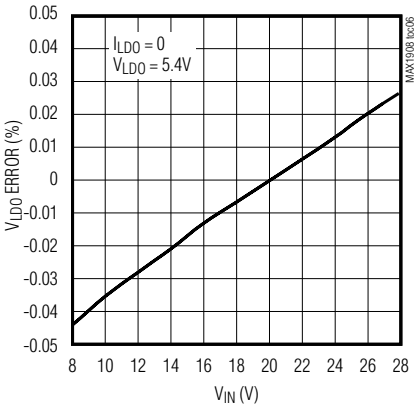


ICTL = LDO
VCTL = LDO
I_{CHARGE} = 3A
LINE STEP 18.5V TO 27.5V

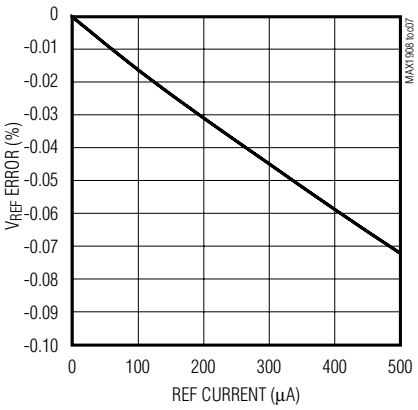
LDO LOAD REGULATION



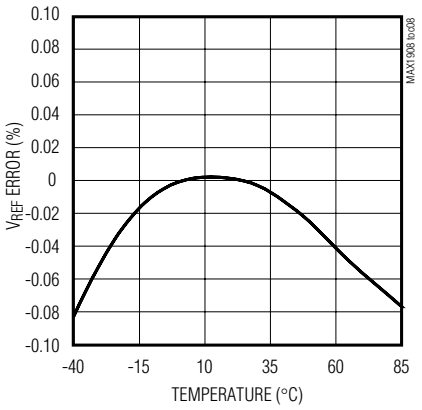
LDO LINE REGULATION



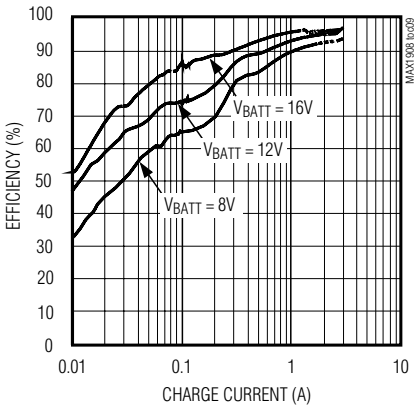
REF VOLTAGE LOAD REGULATION



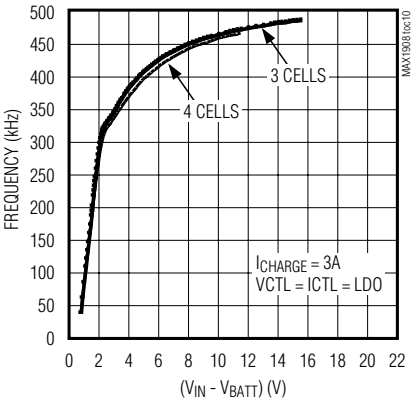
REF VOLTAGE ERROR vs. TEMPERATURE



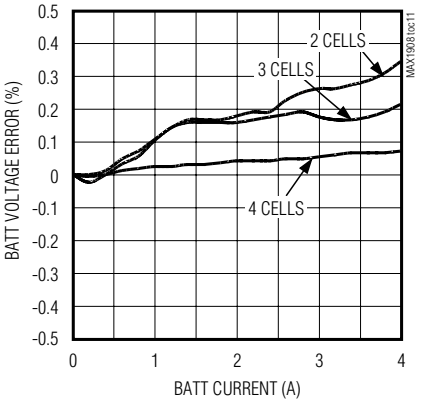
EFFICIENCY vs. CHARGE CURRENT



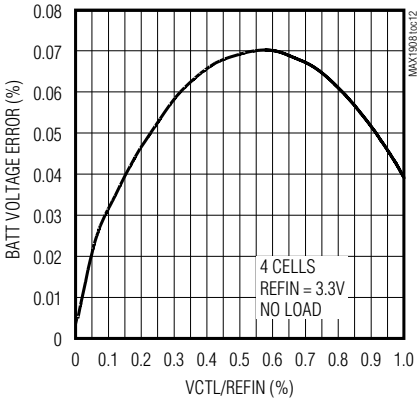
FREQUENCY vs. V_{IN} - V_{BATT}



OUTPUT V/I CHARACTERISTICS



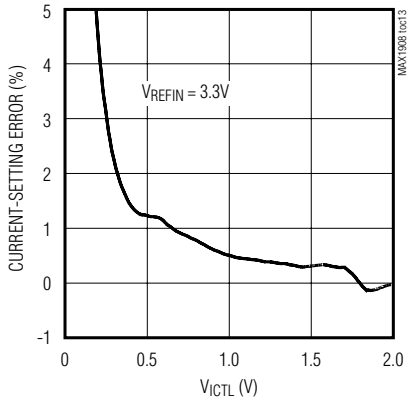
BATT VOLTAGE ERROR vs. VCTL



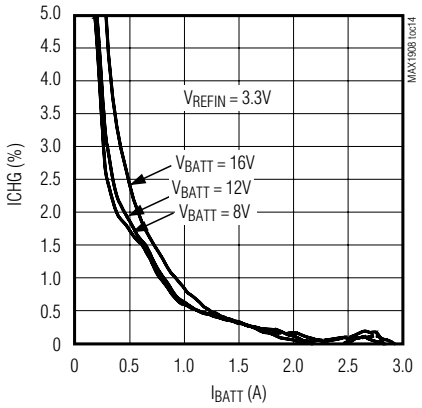
Typical Operating Characteristics (continued)

(Circuit of Figure 1, V_{DCIN} = 20V, T_A = +25°C, unless otherwise noted.)

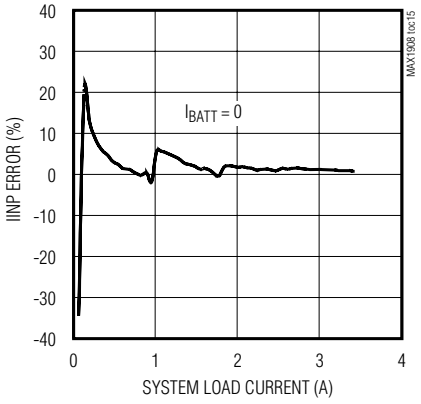
CURRENT-SETTING ERROR vs. ICTL



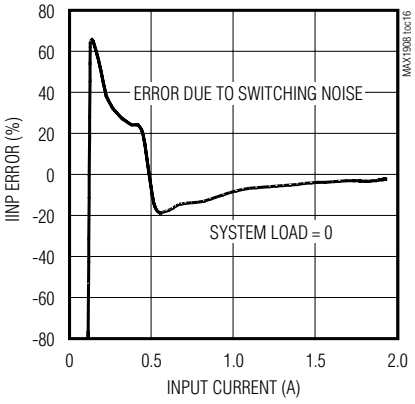
ICHG ERROR vs. CHARGE CURRENT



IINP ERROR vs. SYSTEM LOAD CURRENT



IINP ERROR vs. INPUT CURRENT



Pin Description

PIN	NAME	FUNCTION
1	DCIN	Charging Voltage Input. Bypass DCIN with a 1µF capacitor to PGND.
2	LDO	Device Power Supply. Output of the 5.4V linear regulator supplied from DCIN. Bypass with a 1µF capacitor to GND.
3	CLS	Source Current-Limit Input. Voltage input for setting the current limit of the input source.
4	REF	4.096V Voltage Reference. Bypass REF with a 1µF capacitor to GND.
5	CCS	Input-Current Regulation Loop-Compensation Point. Connect a 0.01µF capacitor to GND.
6	CCI	Output-Current Regulation Loop-Compensation Point. Connect a 0.01µF capacitor to GND.
7	CCV	Voltage Regulation Loop-Compensation Point. Connect 1kΩ in series with a 0.1µF capacitor to GND.
8	$\overline{SHDN}$	Shutdown Control Input. Drive $\overline{SHDN}$ logic low to shut down the MAX1908/MAX8724/MAX8765 MAX8765A. Use with a thermistor to detect a hot battery and suspend charging.
9	ICHG	Charge-Current Monitor Output. ICHG is a scaled-down replica of the charger output current. Use ICHG to monitor the charging current and detect when the chip changes from constant-current mode to constant-voltage mode. The transconductance of (CSIP - CSIN) to ICHG is 3µA/mV.
10	ACIN	AC Detect Input. Input to an uncommitted comparator. ACIN can be used to detect AC-adapter presence.
11	$\overline{ACOK}$	AC Detect Output. High-voltage open-drain output is high impedance when V_{ACIN} is less than $V_{REF}/2$.
12	REFIN	Reference Input. Allows the ICTL and VCTL inputs to have ratiometric ranges for increased accuracy.
13	ICTL	Output Current-Limit Set Input. ICTL input voltage range is $V_{REFIN}/32$ to V_{REFIN}. The MAX1908/MAX8724 shut down if ICTL is forced below $V_{REFIN}/100$ while the MAX8765/MAX8765A does not. When ICTL is equal to LDO, the set point for CSIP - CSIN is 45mV.
14	GND	Analog Ground
15	VCTL	Output Voltage-Limit Set Input. VCTL input voltage range is 0 to V_{REFIN}. When VCTL is equal to LDO, the set point is (4.2 x CELLS)V.
16	BATT	Battery Voltage Input
17	CELLS	Cell Count Input. Tri-level input for setting number of cells. GND = 2 cells, open = 3 cells, REFIN = 4 cells.
18	CSIN	Output Current-Sense Negative Input
19	CSIP	Output Current-Sense Positive Input. Connect a current-sense resistor from CSIP to CSIN.
20	PGND	Power Ground
21	DLO	Low-Side Power MOSFET Driver Output. Connect to low-side nMOS gate.
22	DLOV	Low-Side Driver Supply. Bypass DLOV with a 1µF capacitor to GND.
23	LX	High-Side Power MOSFET Driver Power-Return Connection. Connect to the source of the high-side nMOS.
24	BST	High-Side Power MOSFET Driver Power-Supply Connection. Connect a 0.1µF capacitor from LX to BST.
25	DHI	High-Side Power MOSFET Driver Output. Connect to high-side nMOS gate.
26	CSSN	Input Current-Sense Negative Input
27	CSSP	Input Current-Sense Positive Input. Connect a current-sense resistor from CSSP to CSSN.
28	IINP	Input-Current Monitor Output. IINP is a scaled-down replica of the input current. IINP monitors the total system current. The transconductance of (CSSP - CSSN) to IINP is 3µA/mV.

Detailed Description

The MAX1908/MAX8724/MAX8765/MAX8765A include all the functions necessary to charge Li+ batteries. A high-efficiency synchronous-rectified step-down DC-DC converter controls charging voltage and current. The device also includes input-source current limiting and analog inputs for setting the charge current and charge voltage. Control charge current and voltage using the ICTL and VCTL inputs, respectively. Both ICTL and VCTL are ratiometric with respect to REFIN, allowing compatibility with DACs or microcontrollers (µCs). Ratiometric ICTL and VCTL improve the accuracy of the charge current and voltage set point by matching V_{REFIN} to the reference of the host. For standard applications, internal set points for ICTL and VCTL provide 3A charge current (with 0.015Ω sense resistor), and 4.2V (per cell) charge voltage. Connect ICTL and VCTL to LDO to select the internal set points. The MAX1908 safely conditions overdischarged cells with 300mA (with 0.015Ω sense resistor) until the battery-pack voltage exceeds 3.1V × number of series-connected cells. The $\overline{SHDN}$ input allows shutdown from a microcontroller or thermistor.

The DC-DC converter uses external n-channel MOSFETs as the buck switch and synchronous rectifier to convert the input voltage to the required charging current and voltage. The *Typical Application Circuit* shown in Figure 1 uses a µC to control charging current, while Figure 2 shows a typical application with charging voltage and current fixed to specific values for the application. The voltage at ICTL and the value of RS2 set the charging current. The DC-DC converter generates the control signals for the external MOSFETs to regulate the voltage and the current set by the VCTL, ICTL, and CELLS inputs.

The MAX1908/MAX8724/MAX8765/MAX8765A feature a voltage regulation loop (CCV) and two current regulation loops (CCI and CCS). The CCV voltage regulation loop monitors BATT to ensure that its voltage does not exceed the voltage set by VCTL. The CCI battery current regulation loop monitors current delivered to BATT to ensure that it does not exceed the current limit set by ICTL. A third loop (CCS) takes control and reduces the battery-charging current when the sum of the system load and the battery-charging input current exceeds the input current limit set by CLS.

Setting the Battery-Regulation Voltage

The MAX1908/MAX8724/MAX8765/MAX8765A use a high-accuracy voltage regulator for charging voltage. The VCTL input adjusts the charger output voltage. VCTL control voltage can vary from 0 to V_{REFIN}, providing a 10% adjustment range on the V_{BATT} regulation voltage. By limiting the adjust range to 10% of the regulation voltage, the external resistor mismatch error is reduced from 1% to 0.05% of the regulation voltage. Therefore, an overall voltage accuracy of better than 0.7% is maintained while using 1% resistors. The per-cell battery termination voltage is a function of the battery chemistry. Consult the battery manufacturer to determine this voltage. Connect VCTL to LDO to select the internal default setting V_{BATT} = 4.2V × number of cells, or program the battery voltage with the following equation:

$$V_{BATT} = CELLS \times \left(4V + \left(0.4 \times \frac{V_{VCTL}}{V_{REFIN}}\right)\right)$$

CELLS is the programming input for selecting cell count. Connect CELLS as shown in Table 2 to charge 2, 3, or 4 Li+ cells. When charging other cell chemistries, use CELLS to select an output voltage range for the charger.

The internal error amplifier (GMV) maintains voltage regulation (Figure 3). The voltage error amplifier is compensated at CCV. The component values shown in Figures 1 and 2 provide suitable performance for most applications. Individual compensation of the voltage regulation and current regulation loops allows for optimal compensation (see the *Compensation* section).

Table 1. Versions Comparison

DESCRIPTION	MAX1908	MAX8724	MAX8765/ MAX8765A
Conditioning Charge Feature	Yes	No	No
ICTL Shutdown Mode	Yes	Yes	No
$\overline{ACOK}$ Enable Condition	REFIN must be ready	REFIN must be ready	Independent of REFIN

Table 2. Cell-Count Programming

CELLS	CELL COUNT
GND	2
Open	3
V_{REFIN}	4

Typical Application Circuits

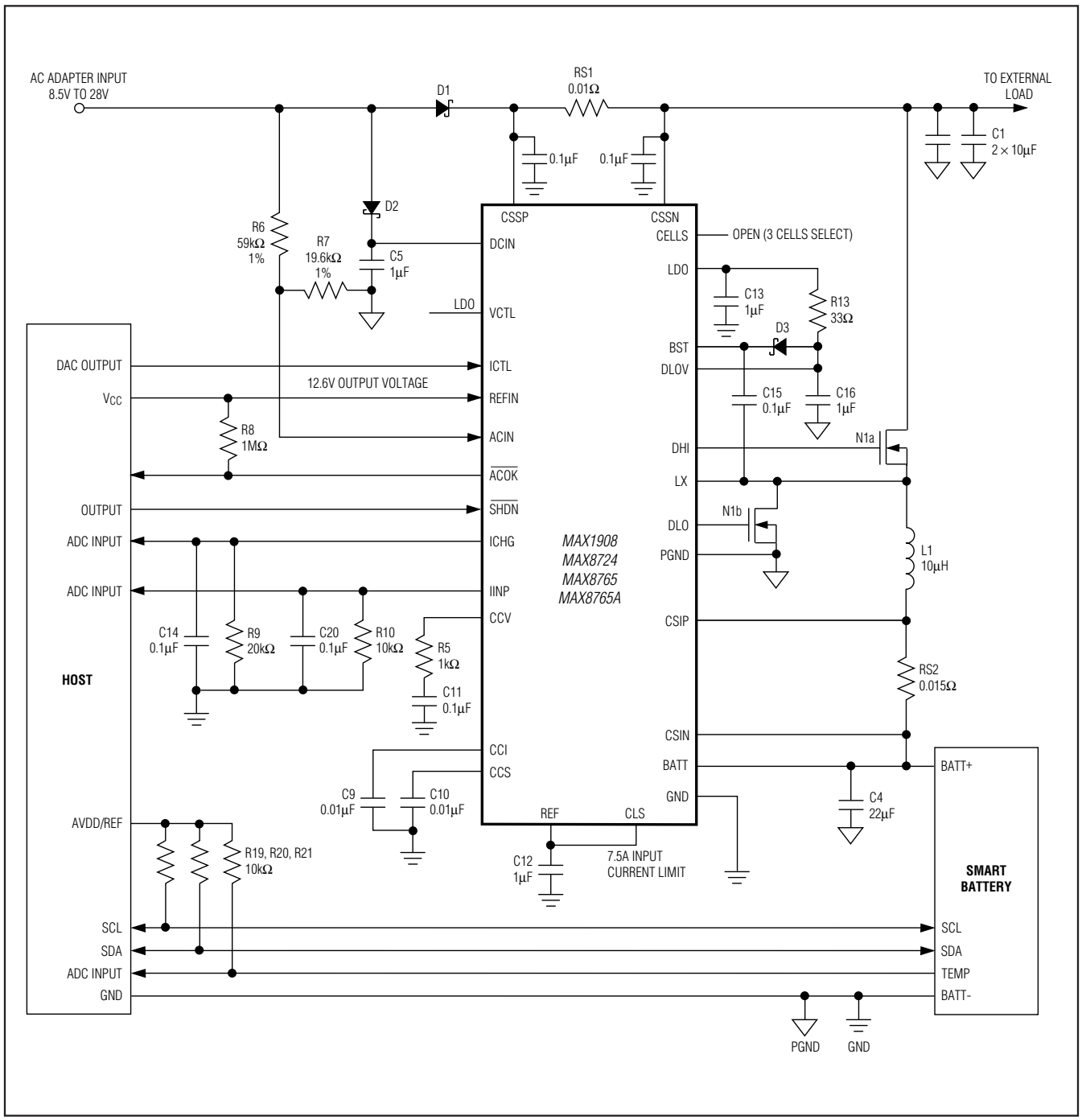


Figure 1. µC-Controlled Typical Application Circuit

Typical Application Circuits (continued)

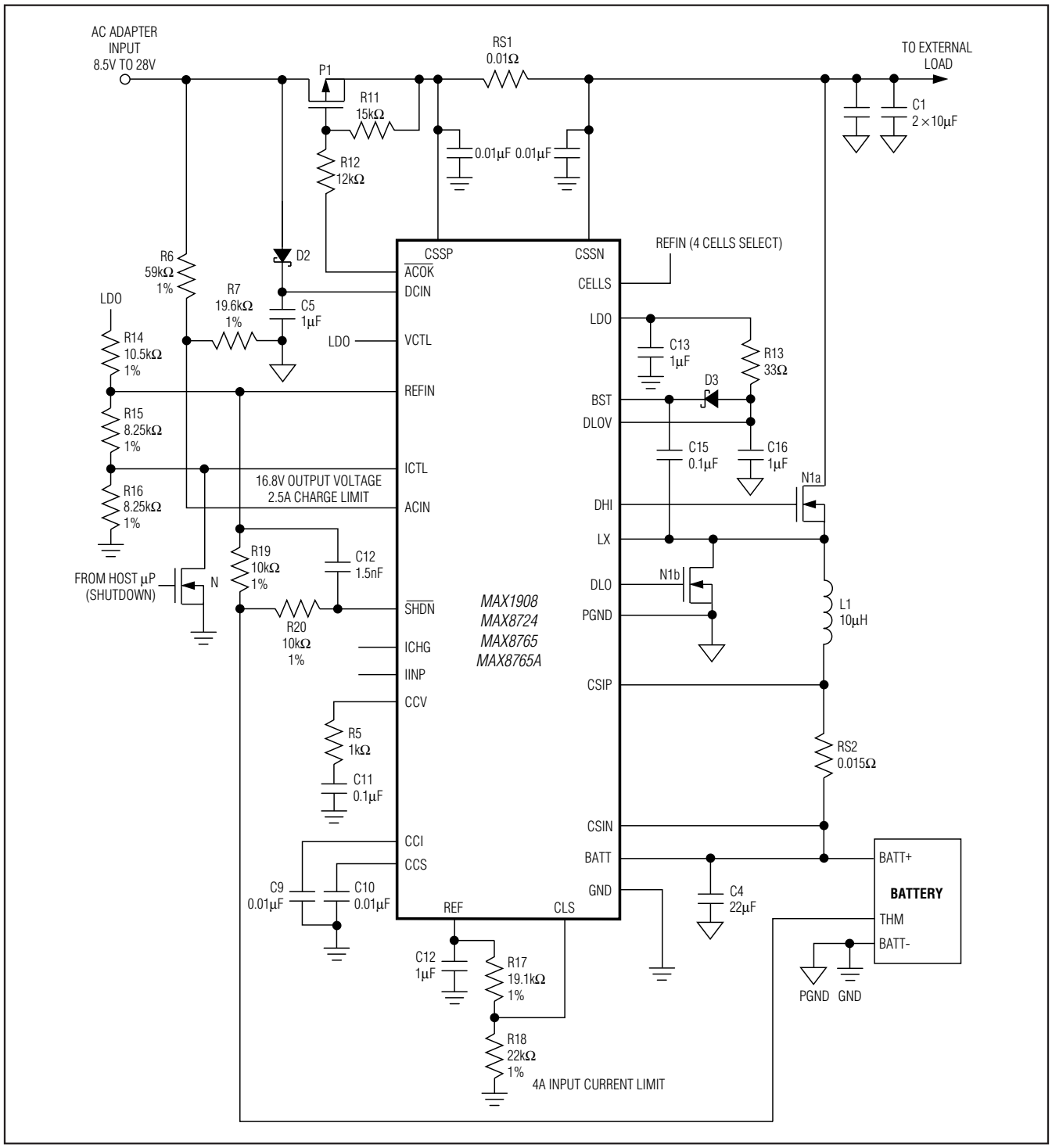


Figure 2. Typical Application Circuit with Fixed Charging Parameters

Functional Diagram

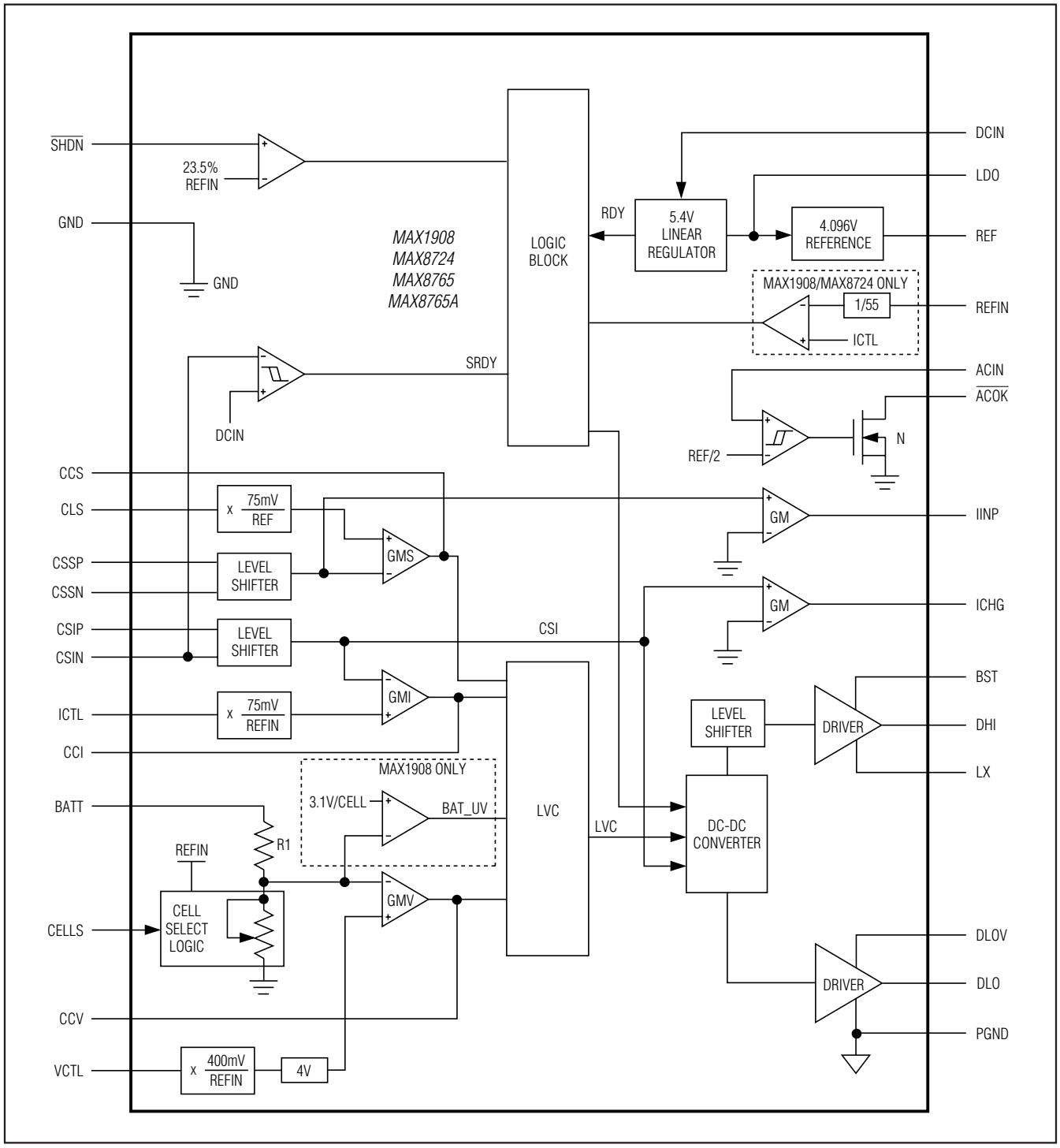


Figure 3. Functional Diagram

Setting the Charging-Current Limit

The ICTL input sets the maximum charging current. The current is set by current-sense resistor RS2, connected between CSIP and CSIN. The full-scale differential voltage between CSIP and CSIN is 75mV; thus, for a 0.015Ω sense resistor, the maximum charging current is 5A. Battery-charging current is programmed with ICTL using the equation:

$$I_{CHG} = \frac{V_{ICTL}}{V_{REFIN}} \times \frac{0.075}{RS2}$$

The input voltage range for ICTL is $V_{REFIN}/32$ to V_{REFIN}. The MAX1908/MAX8724 shut down if ICTL is forced below $V_{REFIN}/100$ (min), while the MAX8765/MAX8765A does not.

Connect ICTL to LDO to select the internal default full-scale, charge-current sense voltage of 45mV. The charge current when ICTL = LDO is:

$$I_{CHG} = \frac{0.045V}{RS2}$$

where RS2 is 0.015Ω, providing a charge-current set point of 3A.

The current at the ICHG output is a scaled-down replica of the battery output current being sensed across CSIP and CSIN (see the *Current Measurement* section).

When choosing the current-sense resistor, note that the voltage drop across this resistor causes further power loss, reducing efficiency. However, adjusting ICTL to reduce the voltage across the current-sense resistor can degrade accuracy due to the smaller signal to the input of the current-sense amplifier. The charging-current-error amplifier (GMI) is compensated at CCI (see the *Compensation* section).

Setting the Input Current Limit

The total input current (from an AC adapter or other DC source) is a function of the system supply current and the battery-charging current. The input current regulator limits the input current by reducing the charging current when the input current exceeds the input current-limit set point. System current normally fluctuates as portions of the system are powered up or down. Without input current regulation, the source must be able to supply the maximum system current and the maximum charger input current simultaneously. By using the input current limiter, the current capability of the AC adapter can be lowered, reducing system cost.

The MAX1908/MAX8724/MAX8765/MAX8765A limit the battery charge current when the input current-limit threshold is exceeded, ensuring the battery charger does not load down the AC adapter voltage. An internal amplifier compares the voltage between CSSP and CSSN to the voltage at CLS. V_{CLS} can be set by a resistive divider between REF and GND. Connect CLS to REF for the full-scale input current limit. The CLS voltage range for the MAX1908/MAX8724 is from 1.6V to REF, while the MAX8765/MAX8765A CLS voltage is from 1.1V to REF.

The input current is the sum of the device current, the charger input current, and the load current. The device current is minimal (3.8mA) in comparison to the charge and load currents. Determine the actual input current required as follows:

$$I_{INPUT} = I_{LOAD} + \left(\frac{I_{CHG} \times V_{BATT}}{V_{IN} \times \eta} \right)$$

where η is the efficiency of the DC-DC converter.

V_{CLS} determines the reference voltage of the GMS error amplifier. Sense resistor RS1 and V_{CLS} determine the maximum allowable input current. Calculate the input current limit as follows:

$$I_{INPUT} = \frac{V_{CLS}}{V_{REF}} \times \frac{0.075}{RS1}$$

Once the input current limit is reached, the charging current is reduced until the input current is at the desired threshold.

When choosing the current-sense resistor, note that the voltage drop across this resistor causes further power loss, reducing efficiency. Choose the smallest value for RS1 that achieves the accuracy requirement for the input current-limit set point.

Conditioning Charge

The MAX1908 includes a battery-voltage comparator that allows a conditioning charge of overdischarged Li+ battery packs. If the battery-pack voltage is less than 3.1V × number of cells programmed by CELLS, the MAX1908 charges the battery with 300mA current when using sense resistor RS2 = 0.015Ω. After the battery voltage exceeds the conditioning charge threshold, the MAX1908 resumes full-charge mode, charging to the programmed voltage and current limits. The MAX8724/MAX8765/MAX8765A do not offer this feature.

AC Adapter Detection

Connect the AC adapter voltage through a resistive divider to ACIN to detect when AC power is available, as shown in Figure 1. ACIN voltage rising trip point is $V_{REF}/2$ with 20mV hysteresis. $\overline{ACOK}$ is an open-drain output and is high impedance when ACIN is less than

$V_{REF}/2$. Since $\overline{ACOK}$ can withstand 30V (max), $\overline{ACOK}$ can drive a p-channel MOSFET directly at the charger input, providing a lower dropout voltage than a Schottky diode (Figure 2). In the MAX1908/MAX8724 the $\overline{ACOK}$ comparator is enabled after REFIN is ready. In the MAX8765/MAX8765A, the $\overline{ACOK}$ comparator is independent of REFIN.

Current Measurement

Use ICHG to monitor the battery-charging current being sensed across CSIP and CSIN. The ICHG voltage is proportional to the output current by the equation:

$$V_{ICHG} = ICHG \times RS2 \times G_{ICHG} \times R9$$

where I_{CHG} is the battery-charging current, G_{ICHG} is the transconductance of ICHG (3µA/mV typ), and R9 is the resistor connected between ICHG and ground. Leave ICHG unconnected if not used.

Use IINP to monitor the system input current being sensed across CSSP and CSSN. The voltage of IINP is proportional to the input current by the equation:

$$V_{IINP} = I_{INPUT} \times RS1 \times G_{IINP} \times R10$$

where I_{INPUT} is the DC current being supplied by the AC adapter power, G_{IINP} is the transconductance of IINP (3µA/mV typ), and R10 is the resistor connected between IINP and ground. ICHG and IINP have a 0 to 3.5V output voltage range. Leave IINP unconnected if not used.

LDO Regulator

LDO provides a 5.4V supply derived from DCIN and can deliver up to 10mA of load current. The MOSFET drivers are powered by DLOV and BST, which must be connected to LDO as shown in Figure 1. LDO supplies the 4.096V reference (REF) and most of the control circuitry. Bypass LDO with a 1µF capacitor to GND.

Shutdown

The MAX1908/MAX8724/MAX8765/MAX8765A feature a low-power shutdown mode. Driving $\overline{SHDN}$ low shuts down the MAX1908/MAX8724/MAX8765/MAX8765A. In shutdown, the DC-DC converter is disabled and CCI, CCS, and CCV are pulled to ground. The IINP and $\overline{ACOK}$ outputs continue to function.

$\overline{SHDN}$ can be driven by a thermistor to allow automatic shutdown of the MAX1908/MAX8724/MAX8765/MAX8765A when the battery pack is hot. The shutdown falling threshold is 23.5% (typ) of V_{REFIN} with 1% V_{REFIN} hysteresis to provide smooth shutdown when driven by a thermistor.

DC-DC Converter

The MAX1908/MAX8724/MAX8765/MAX8765A employ a buck regulator with a bootstrapped nMOS high-side switch and a low-side nMOS synchronous rectifier.

CCV, CCI, CCS, and LVC Control Blocks

The MAX1908/MAX8724/MAX8765/MAX8765A control input current (CCS control loop), charge current (CCI control loop), or charge voltage (CCV control loop), depending on the operating condition.

The three control loops, CCV, CCI, and CCS are brought together internally at the LVC amplifier (lowest voltage clamp). The output of the LVC amplifier is the feedback control signal for the DC-DC controller. The output of the G_M amplifier that is the lowest sets the output of the LVC amplifier and also clamps the other two control loops to within 0.3V above the control point. Clamping the other two control loops close to the lowest control loop ensures fast transition with minimal overshoot when switching between different control loops.

DC-DC Controller

The MAX1908/MAX8724/MAX8765/MAX8765A feature a variable off-time, cycle-by-cycle current-mode control scheme. Depending upon the conditions, the MAX1908/MAX8724/MAX8765/MAX8765A work in continuous or discontinuous-conduction mode.

Continuous-Conduction Mode

With sufficient charger loading, the MAX1908/MAX8724/MAX8765/MAX8765A operate in continuous-conduction mode (inductor current never reaches zero) switching at 400kHz if the BATT voltage is within the following range:

$$3.1V \times (\text{number of cells}) < V_{BATT} < (0.88 \times V_{DCIN})$$

The operation of the DC-DC controller is controlled by the following four comparators as shown in Figure 4:

- **IMIN**—Compares the control point (LVC) against 0.15V (typ). If IMIN output is low, then a new cycle cannot begin.
- **CCMP**—Compares the control point (LVC) against the charging current (CSI). The high-side MOSFET on-time is terminated if the CCMP output is high.
- **IMAX**—Compares the charging current (CSI) to 6A (RS2 = 0.015Ω). The high-side MOSFET on-time is terminated if the IMAX output is high and a new cycle cannot begin until IMAX goes low.
- **ZCMP**—Compares the charging current (CSI) to 333mA (RS2 = 0.015Ω). If ZCMP output is high, then both MOSFETs are turned off.

DC-DC Functional Diagram

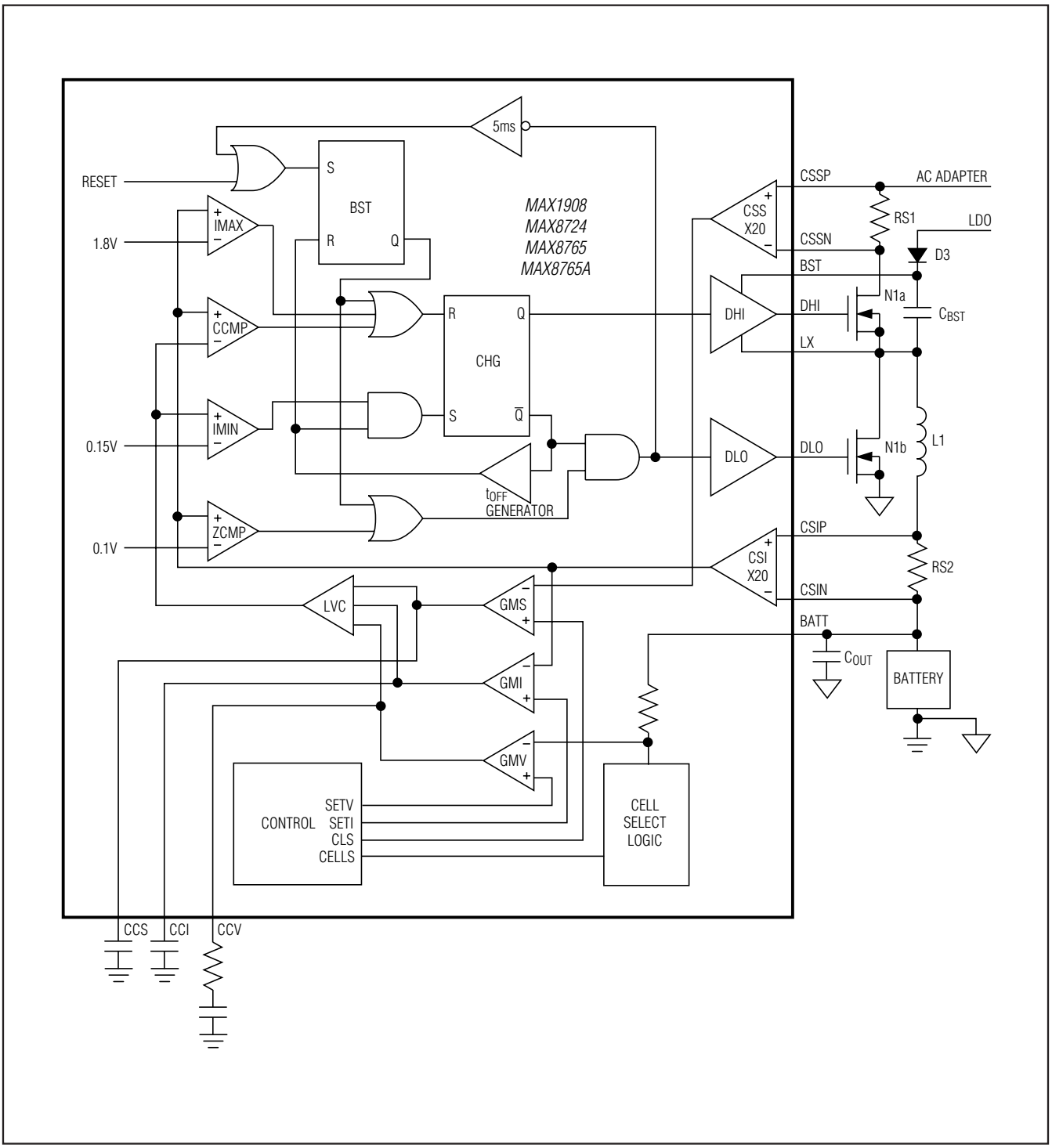


Figure 4. DC-DC Functional Diagram

In normal operation, the controller starts a new cycle by turning on the high-side n-channel MOSFET and turning off the low-side n-channel MOSFET. When the charge current is greater than the control point (LVC), CCMP goes high and the off-time is started. The off-time turns off the high-side n-channel MOSFET and turns on the low-side n-channel MOSFET. The operational frequency is governed by the off-time and is dependent upon V_{DCIN} and V_{BATT}. The off-time is set by the following equations:

$$t_{OFF} = 2.5\mu s \times \frac{V_{DCIN} - V_{BATT}}{V_{DCIN}}$$

$$t_{ON} = \frac{L \times I_{RIPPLE}}{V_{CSSN} - V_{BATT}}$$

where:

$$I_{RIPPLE} = \frac{V_{BATT} \times t_{OFF}}{L}$$

$$f = \frac{1}{t_{ON} + t_{OFF}}$$

These equations result in fixed-frequency operation over the most common operating conditions.

At the end of the fixed off-time, another cycle begins if the control point (LVC) is greater than 0.15V, IMIN = high, and the peak charge current is less than 6A (RS2 = 0.015Ω), IMAX = high. If the charge current exceeds IMAX, the on-time is terminated by the IMAX comparator. IMAX governs the maximum cycle-by-cycle current limit and is internally set to 6A (RS2 = 0.015Ω). IMAX protects against sudden overcurrent faults.

If, during the off-time, the inductor current goes to zero, ZCMP = high, both the high- and low-side MOSFETs are turned off until another cycle is ready to begin.

There is a minimum 0.3µs off-time when the (V_{DCIN} - V_{BATT}) differential becomes too small. If $V_{BATT} \geq 0.88 \times V_{DCIN}$, then the threshold for minimum off-time is reached and the t_{OFF} is fixed at 0.3µs. A maximum on-time of 5ms allows the controller to achieve > 99% duty cycle in continuous-conduction mode. The switching frequency in this mode varies according to the equation:

$$f = \frac{1}{\frac{L \times I_{RIPPLE}}{(V_{CSSN} - V_{BATT})} + 0.3\mu s}$$

Discontinuous Conduction

The MAX1908/MAX8724/MAX8765/MAX8765A enter discontinuous-conduction mode when the output of the LVC control point falls below 0.15V. For RS2 = 0.015Ω, this corresponds to 0.5A:

$$IMIN = \frac{0.15V}{20 \times RS2} = 0.5A$$

for RS2 = 0.015Ω.

In discontinuous mode, a new cycle is not started until the LVC voltage rises above 0.15V. Discontinuous-mode operation can occur during conditioning charge of overdischarged battery packs, when the charge current has been reduced sufficiently by the CCS control loop, or when the battery pack is near full charge (constant-voltage-charging mode).

MOSFET Drivers

The low-side driver output DLO switches between PGND and DLOV. DLOV is usually connected through a filter to LDO. The high-side driver output DHI is bootstrapped off LX and switches between V_{LX} and V_{BST}. When the low-side driver turns on, BST rises to one diode voltage below DLOV.

Filter DLOV with a lowpass filter whose cutoff frequency is approximately 5kHz (Figure 1):

$$f_C = \frac{1}{2\pi RC} = \frac{1}{2\pi \times 33\Omega \times 1\mu F} = 4.8kHz$$

Dropout Operation

The MAX1908/MAX8724/MAX8765/MAX8765A have 99% duty-cycle capability with a 5ms (max) on-time and 0.3µs (min) off-time. This allows the charger to achieve dropout performance limited only by resistive losses in the DC-DC converter components (D1, N1, RS1, and RS2, Figure 1). Replacing diode D1 with a p-channel MOSFET driven by $\overline{ACOK}$ improves dropout performance (Figure 2). The dropout voltage is set by the difference between DCIN and CSIN. When the dropout voltage falls below 100mV, the charger is disabled; 200mV hysteresis ensures that the charger does not turn back on until the dropout voltage rises to 300mV.

Compensation

Each of the three regulation loops—input current limit, charging current limit, and charging voltage limit—are compensated separately using CCS, CCI, and CCV, respectively.

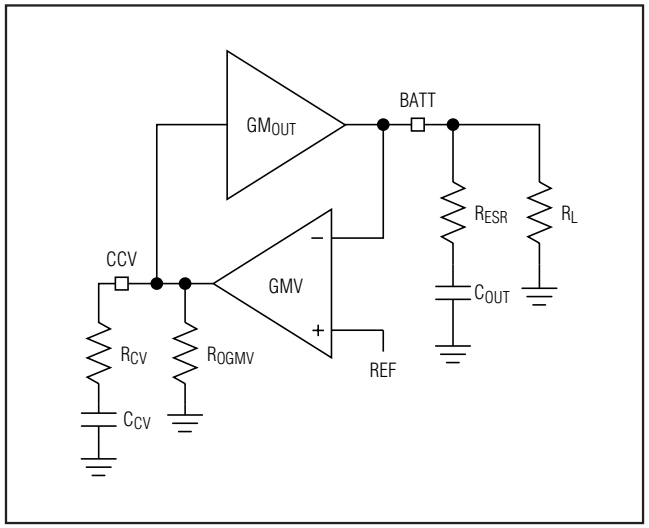


Figure 5. CCV Loop Diagram

CCV Loop Definitions

Compensation of the CCV loop depends on the parameters and components shown in Figure 5. C_{CV} and R_{CV} are the CCV loop compensation capacitor and series resistor. R_{ESR} is the equivalent series resistance (ESR) of the charger output capacitor (C_{OUT}). R_L is the equivalent charger output load, where $R_L = V_{BATT}/I_{CHG}$. The equivalent output impedance of the GMV amplifier, $R_{OGMV} \geq 10M\Omega$. The voltage amplifier transconductance, GMV = 0.125µA/mV. The DC-DC converter transconductance, GM_{OUT} = 3.33A/V:

$$GM_{OUT} = \frac{1}{A_{CSI} \times RS2}$$

where A_{CSI} = 20, and RS2 is the charging current-sense resistor in the *Typical Application Circuits*.

The compensation pole is given by:

$$f_{P\_CV} = \frac{1}{2\pi R_{OGMV} \times C_{CV}}$$

The compensation zero is given by:

$$f_{Z\_CV} = \frac{1}{2\pi R_{CV} \times C_{CV}}$$

The output pole is given by:

$$f_{P\_OUT} = \frac{1}{2\pi R_L \times C_{OUT}}$$

where R_L varies with load according to $R_L = V_{BATT}/I_{CHG}$.

Output zero due to output capacitor ESR:

$$f_{Z\_ESR} = \frac{1}{2\pi R_{ESR} \times C_{OUT}}$$

The loop transfer function is given by:

$$LTF = GM_{OUT} \times R_L \times GMV \times R_{OGMV} \times \frac{(1+sC_{OUT} \times R_{ESR})(1+sC_{CV} \times R_{CV})}{(1+sC_{CV} \times R_{OGMV})(1+sC_{OUT} \times R_L)}$$

Assuming the compensation pole is a very low frequency, and the output zero is a much higher frequency, the crossover frequency is given by:

$$f_{CO\_CV} = \frac{GMV \times R_{CV} \times GM_{OUT}}{2\pi C_{OUT}}$$

To calculate R_{CV} and C_{CV} values of the circuit of Figure 2:
Cells = 4
C_{OUT} = 22µF
V_{BATT} = 16.8V
I_{CHG} = 2.5A
GMV = 0.125µA/mV
GM_{OUT} = 3.33A/V
R_{OGMV} = 10MΩ
f = 400kHz

Choose crossover frequency to be 1/5th the MAX1908's 400kHz switching frequency:

$$f_{CO\_CV} = \frac{GMV \times R_{CV} \times GM_{OUT}}{2\pi C_{OUT}} = 80kHz$$

Solving yields R_{CV} = 26kΩ.

Conservatively set R_{CV} = 1kΩ, which sets the crossover frequency at:

$$f_{CO\_CV} = 3kHz$$

Choose the output-capacitor ESR so the output-capacitor zero is 10 times the crossover frequency:

$$R_{ESR} = \frac{1}{2\pi \times 10 \times f_{CO\_CV} \times C_{OUT}} = 0.24\Omega$$

$$f_{Z\_ESR} = \frac{1}{2\pi R_{ESR} \times C_{OUT}} = 2.412MHz$$

The 22µF ceramic capacitor has a typical ESR of 0.003Ω, which sets the output zero at 2.412MHz.

The output pole is set at:

$$f_{P\_OUT} = \frac{1}{2\pi R_L \times C_{OUT}} = 1.08kHz$$

where:

$$R_L = \frac{\Delta V_{BATT}}{\Delta I_{CHG}} = \text{Battery ESR}$$

Set the compensation zero (f_{Z_CV}) so it is equivalent to the output pole (f_{P_OUT} = 1.08kHz), effectively producing a pole-zero cancellation and maintaining a single-pole system response:

$$f_{Z\_CV} = \frac{1}{2\pi R_{CV} \times C_{CV}}$$

$$C_{CV} = \frac{1}{2\pi R_{CV} \times 1.08kHz} = 147nF$$

Choose C_{CV} = 100nF, which sets the compensation zero (f_{Z_CV}) at 1.6kHz. This sets the compensation pole:

$$f_{P\_CV} = \frac{1}{2\pi R_{OGMV} \times C_{CV}} = 0.16Hz$$

CCI Loop Definitions

Compensation of the CCI loop depends on the parameters and components shown in Figure 7. C_{CI} is the CCI loop compensation capacitor. A_{CSI} is the internal gain of the current-sense amplifier. RS2 is the charge current-sense resistor, RS2 = 15mΩ. R_{OGMI} is the equivalent output impedance of the GMI amplifier ≥ 10MΩ. GMI is the charge-current amplifier transconductance = 1µA/mV. GM_{OUT} is the DC-DC converter transconductance = 3.3A/V. The CCI loop is a single-pole system with a dominant pole compensation set by f_{P_CI}:

$$f_{P\_CI} = \frac{1}{2\pi R_{OGMI} \times C_{CI}}$$

The loop transfer function is given by:

$$LTF = GM_{OUT} \times A_{CSI} \times RS2 \times GMI \frac{R_{OGMI}}{1 + sR_{OGMI} \times C_{CI}}$$

Since:

$$GM_{OUT} = \frac{1}{A_{CSI} \times RS2}$$

The loop transfer function simplifies to:

$$LTF = GMI \times \frac{R_{OGMI}}{1 + sR_{OGMI} \times C_{CI}}$$

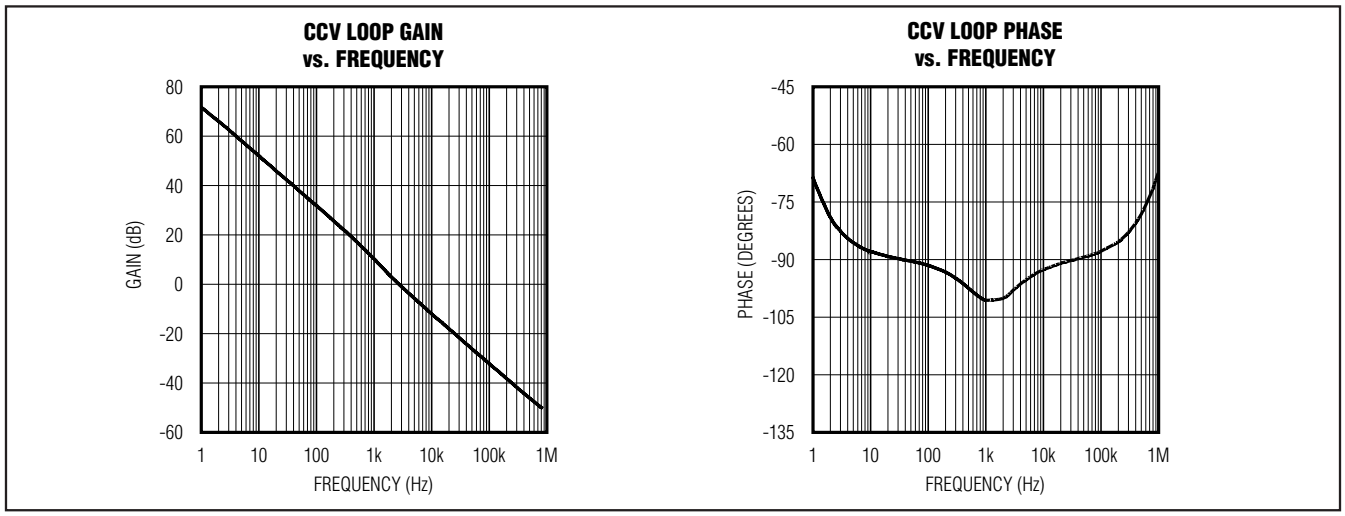


Figure 6. CCV Loop Gain/Phase vs. Frequency

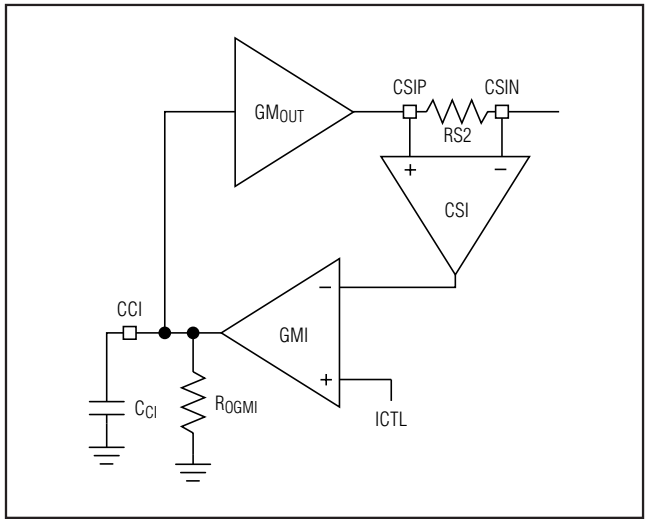


Figure 7. CCI Loop Diagram

The crossover frequency is given by:

$$f_{CO\_CI} = \frac{GMI}{2\pi C_{CI}}$$

The CCI loop dominant compensation pole:

$$f_{P\_CI} = \frac{1}{2\pi R_{OGMI} \times C_{CI}}$$

where the GMI amplifier output impedance, R_{OGMI} = 10MΩ.

To calculate the CCI loop compensation pole, C_{CI}:

GMI = 1µA/mV

GM_{OUT} = 3.33A/V

R_{OGMI} = 10MΩ

f = 400kHz

Choose crossover frequency f_{CO_CI} to be 1/5th the MAX1908/MAX8724/MAX8765/MAX8765A switching frequency:

$$f_{CO\_CI} = \frac{GMI}{2\pi C_{CI}} = 80kHz$$

Solving for C_{CI}, C_{CI} = 2nF.

To be conservative, set C_{CI} = 10nF, which sets the crossover frequency at:

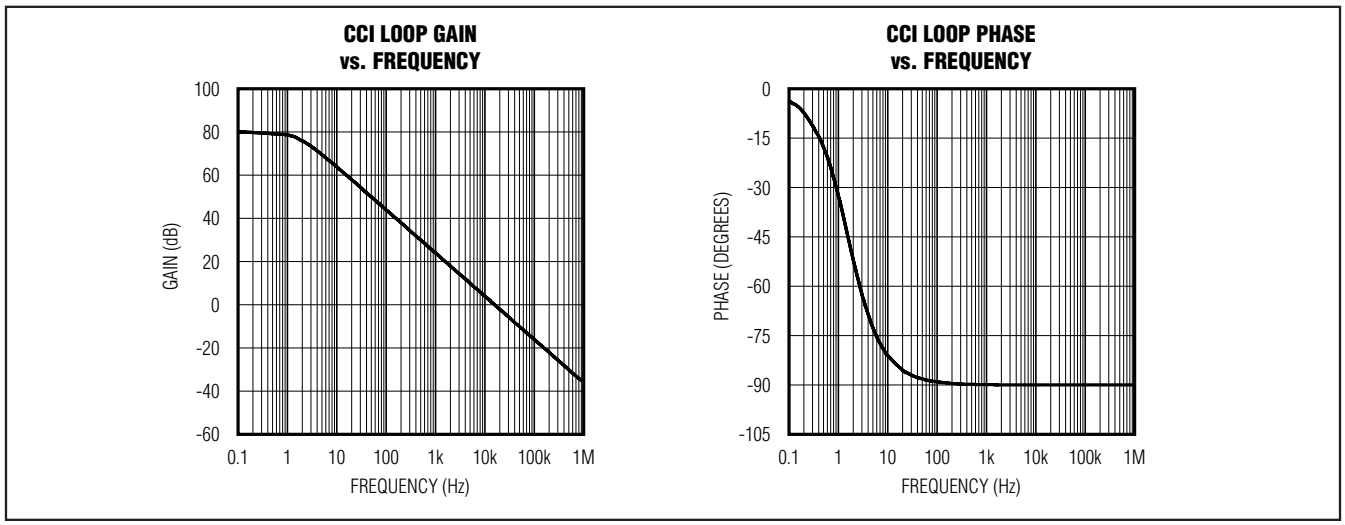
$$f_{CO\_CI} = \frac{GMI}{2\pi 10nF} = 16kHz$$

The compensation pole, f_{P_CI} is set at:

$$f_{P\_CI} = \frac{GMI}{2\pi R_{OGMI} \times C_{CI}} = 0.0016Hz$$

CCS Loop Definitions

Compensation of the CCS loop depends on the parameters and components shown in Figure 9. C_{CS} is the CCS loop compensation capacitor. A_{CSS} is the internal gain of the current-sense amplifier. RS1 is the input current-sense resistor, RS1 = 10mΩ. R_{OGMS} is the equivalent output impedance of the GMS amplifier ≥ 10MΩ. GMS is



the charge-current amplifier transconductance = 1µA/mV. GM_{IN} is the DC-DC converter transconductance = 3.3A/V. The CCS loop is a single-pole system with a dominant pole compensation set by f_{P_CS}:

$$f_{P\_CS} = \frac{1}{2\pi R_{OGMS} \times C_{CS}}$$

The loop transfer function is given by:

$$LTF = GM_{IN} \times A_{CSS} \times RS1 \times GMS \times \frac{R_{OGMS}}{1 + sR_{OGMS} \times C_{CS}}$$

Since:

$$GM_{IN} = \frac{1}{A_{CSS} \times RS1}$$

Then, the loop transfer function simplifies to:

$$LTF = GMS \times \frac{R_{OGMS}}{1 + sR_{OGMS} \times C_{CS}}$$

The crossover frequency is given by:

$$f_{CO\_CS} = \frac{GMS}{2\pi C_{CS}}$$

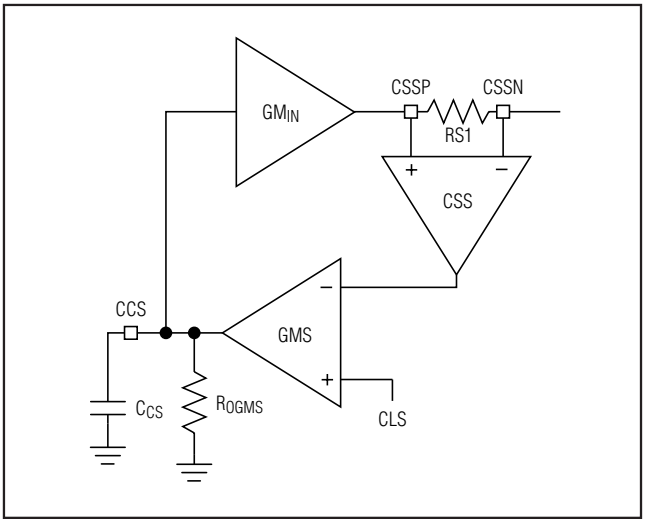


Figure 9. CCS Loop Diagram

The CCS loop dominant compensation pole:

$$f_{P\_CS} = \frac{1}{2\pi R_{OGMS} \times C_{CS}}$$

where the GMS amplifier output impedance, R_{OGMS} = 10MΩ.

To calculate the CCI loop compensation pole, C_{CS}:

GMS = 1µA/mV

GM_{IN} = 3.33A/V

R_{OGMS} = 10MΩ

f = 400kHz

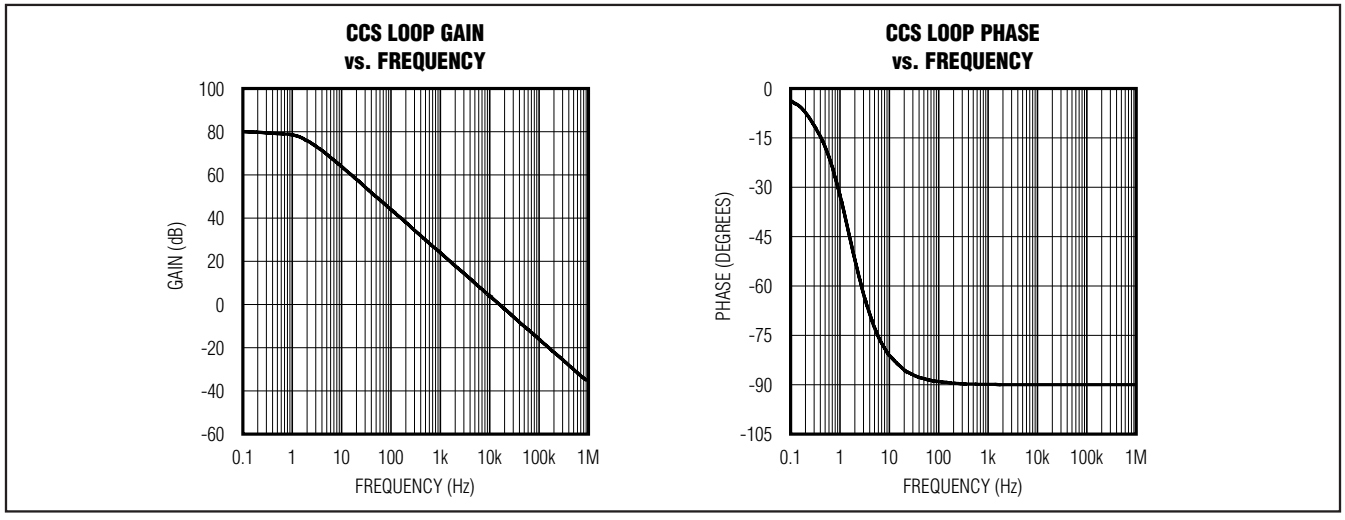


Figure 10. CCS Loop Gain/Phase vs. Frequency